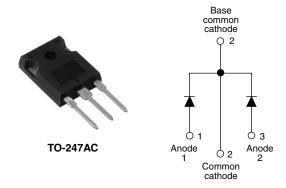


Vishay High Power Products

HEXFRED® Ultrafast Soft Recovery Diode, 2 x 16 A



PRODUCT SUMMARY					
V _R per leg	1200 V				
V _F at 16 A at 25 °C	3.0 V				
I _{F(AV)}	2 x 16 A				
t _{rr} (typical) per leg	5.8 A				
T _J (maximum)	150 °C				
Q _{rr} (typical) per leg	260 nC				
I _{RRM} (typical) per leg	5.8 A				

FEATURES

- Ultrafast recovery
- · Ultrasoft recovery
- Very low I_{RRM}
- Very low Q_{rr}
- · Specified at operating conditions
- · Designed and qualified for industrial level

BENEFITS

- · Reduced RFI and EMI
- · Reduced power loss in diode and switching transistor
- · Higher frequency operation
- · Reduced snubbing
- Reduced parts count

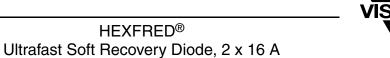
DESCRIPTION

HFA32PA120C is a state of the art ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 1200 V and 16 A per leg continuous current, the HFA32PA120C is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I_{RRM}) and does not exhibit any tendency to "snap-off" during the t_b portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED HFA32PA120C is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Cathode to anode voltage	V_{R}		1200	V		
Maximum continuous forward current per leg	1_	T _C = 100 °C	16			
per device	lF		32	Α		
Single pulse forward current	I_{FSM}		190	A		
Maximum repetitive forward current	I _{FRM}		64			
Maximum nawar disaination	P_{D}	T _C = 25 °C	151	°C		
Maximum power dissipation		T _C = 100 °C	60	O		
Operating junction and storage temperature range	T_J, T_{Stg}		- 55 to + 150	W		

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ELECTRICAL SPECIFICATIONS PER LEG (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V _{BR}	I _R = 100 μA		1200	-	-	
	V _{FM}	I _F = 16 A	See fig. 1	-	2.5	3.0	V
Maximum forward voltage		I _F = 32 A		=	3.2	3.93	
		I _F = 16 A, T _J = 125 °C		-	2.3	2.7	
Maximum reverse		$V_R = V_R$ rated See fig. 2		-	0.75	20	
leakage current	$T_{J} = 125 ^{\circ}\text{C}, V_{R} = 0.8 ^{\circ}\text{X} ^{\circ}\text{Y}_{R} ^{\circ}\text{rated}$ See fig. 2		-	375	2000	μΑ	
Junction capacitance	C _T	V _R = 200 V See fig. 3		=	27	40	pF
Series inductance	L _S	Measured lead to lead 5 mm from package body - 8.0 - nl		nH			

DYNAMIC RECOVERY CHARACTERISTICS PER LEG (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS	
	t _{rr}	$I_F = 1.0 \text{ A}, dI_F/dt = 200 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$		-	30	-	
Reverse recovery time See fig. 5, 10	t _{rr1}	T _J = 25 °C		-	90	135	ns
See lig. 5, 10	t _{rr2}	T _J = 125 °C	I _F = 16 A dI _F /dt = 200 A/μs V _R = 200 V	-	164	245	
Peak recovery current See fig. 6	I _{RRM1}	T _J = 25 °C		-	5.8	10	A nC
	I _{RRM2}	T _J = 125 °C		-	8.3	15	
2	Q _{rr1}	T _J = 25 °C		-	260	675	
	Q _{rr2}	T _J = 125 °C		-	680	1838	IIC
Peak rate of fall of recovery	dI _{(rec)M} /dt1	T _J = 25 °C		-	120	-	- A/μs
current during t _b See fig. 8	dI _{(rec)M} /dt2	T _J = 125 °C		-	76	-	

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Lead temperature	T _{lead}	0.063" from case (1.6 mm) for 10 s	-	-	300	°C	
Thermal resistance, junction to case	R _{thJC}		-	-	0.83		
Thermal resistance, junction to ambient	R _{thJA}	R _{thJA} Typical socket mount		-	80	K/W	
Thermal resistance, case to heatsink	R _{thCS}	Mounting surface, flat, smooth and greased	-	0.50	-		
Woight			-	2.0	-	g	
Weight			-	0.07	-	OZ.	
Mounting torque	ting torque		6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)	
Marking device		Case style TO-247AC (JEDEC)	HFA32PA120C				



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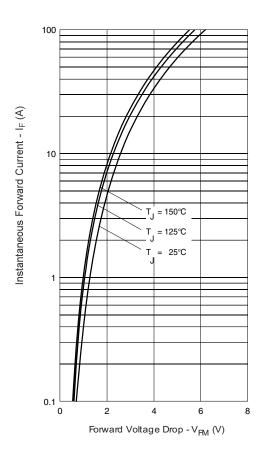


Fig. 2 - Typical Reverse Current vs. Reverse Voltage

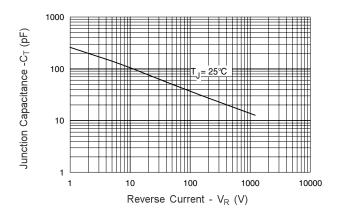


Fig. 1 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

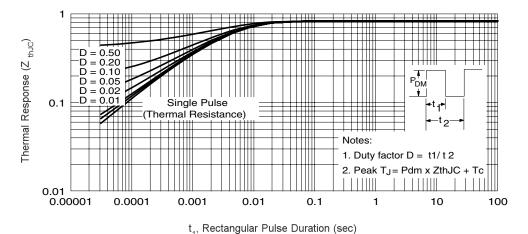


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

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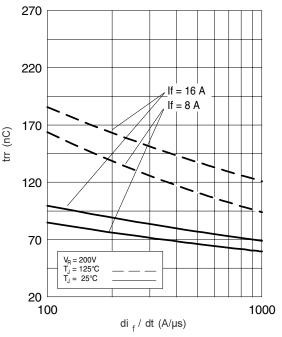


Fig. 5 - Typical Reverse Recovery Time vs. dl_F/dt (Per Leg)

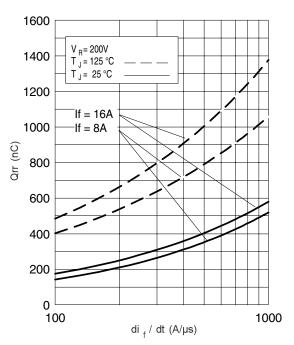


Fig. 7 - Typical Stored Charge vs. dI_F/dt (Per Leg)

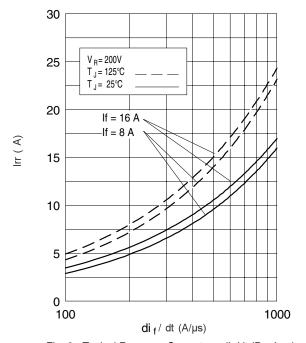


Fig. 6 - Typical Recovery Current vs. dI_F/dt (Per Leg)

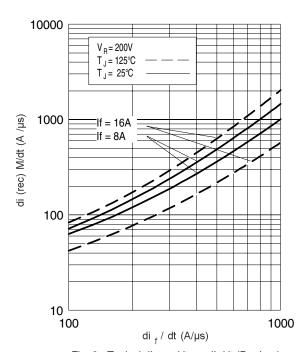


Fig. 8 - Typical $dI_{(rec)M}/dt$ vs. dI_F/dt (Per Leg)



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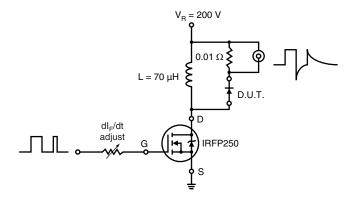
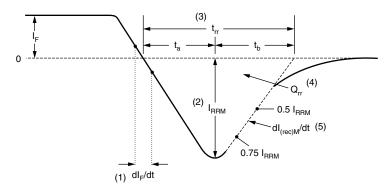


Fig. 9 - Reverse Recovery Parameter Test Circuit



- (1) dl_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- $\begin{array}{l} \text{(3) } \textbf{t}_{\text{rr}} \text{ reverse recovery time measured} \\ \text{from zero crossing point of negative} \\ \text{going I}_{\text{F}} \text{ to point where a line passing} \\ \text{through 0.75 I}_{\text{RRM}} \text{ and 0.50 I}_{\text{RRM}} \\ \text{extrapolated to zero current.} \end{array}$
- (4) \mathbf{Q}_{rr} area under curve defined by \mathbf{t}_{rr} and \mathbf{I}_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) $dI_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

Fig. 10 - Reverse Recovery Waveform and Definitions

HFA32PA120C

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ORDERING INFORMATION TABLE

Device code

HF	A	32	PA	120	C	-
1	2	3	4	5	6	7

- 1 HEXFRED® family
- Process designator: A = Subs. electron irradiated
 B = Subs. platinum
- 3 Current rating (32 = 32 A)
- 4 Package outline (PA = TO-247, 3 pins)
- 5 Voltage rating (120 = 1200 V)
- 6 Configuration (C = Center tap common cathode)
- 7 • None = Standard production
 - PbF = Lead (Pb)-free

LINKS TO RELATED DOCUMENTS					
Dimensions http://www.vishay.com/doc?95223					
Part marking information	http://www.vishay.com/doc?95226				

For technical questions, contact: diodes-tech@vishay.com

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